

GaAs MMIC SMT DOUBLE-BALANCED MIXER, 1.7 - 4.5 GHz



Typical Applications

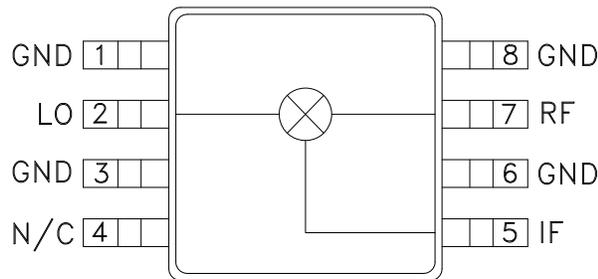
The HMC175MS8 / HMC175MS8E is ideal for:

- Mini-Base Stations
- Portable Wireless
- PCMCIA

Features

- Ultra Small Package: MSOP8
- Conversion Loss: 8 dB
- LO / IF Isolation: 32 dB
- LO / RF Isolation: 30 dB
- Input IP3: +18 dBm

Functional Diagram



General Description

The HMC175MS8 & HMC175MS8E are miniature double-balanced mixers in 8-lead plastic surface mount Mini Small Outline Packages (MSOP). The device can be used as an upconverter or downconverter. The mixer provides exceptional isolation and Intermodulation performance for applications in high signal density environments. This device can also be used as a biphase modulator or demodulator. The MSOP8 is the smallest footprint available for a complete double-balanced mixer (0.118" x 0.190" x 0.040").

Electrical Specifications, $T_A = +25^\circ\text{C}$, LO Drive = +13 dBm

Parameter	Broadband			PCS Band			ISM Band			Units
	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	
Frequency Range, RF & LO	1.7 - 4.5			1.7 - 2.0			2.2 - 2.6			GHz
Frequency Range, IF	DC - 1.0			DC - 1.0			DC - 1.0			GHz
Conversion Loss		8	11		9	11		8	10	dB
Noise Figure (SSB)		8	11		9	11		8	10	dB
LO to RF Isolation	25	30		35	40		30	35		dB
LO to IF Isolation	27	32		28	32		28	32		dB
IP3 (Input)	15	20		15	18		15	18		dBm
1 dB Gain Compression (Input)	9	12		9	11		9	11		dBm

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

For price, delivery, and to place orders: Analog Devices, Inc., One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106 Phone: 781-329-4700 • Order online at www.analog.com Application Support: Phone: 1-800-ANALOG-D

HMC175* PRODUCT PAGE QUICK LINKS

Last Content Update: 02/23/2017

COMPARABLE PARTS

View a parametric search of comparable parts.

EVALUATION KITS

- HMC175MS8 Evaluation Board

DOCUMENTATION

Data Sheet

- HMC175 Data Sheet

TOOLS AND SIMULATIONS

- HMC175 S-Parameters

REFERENCE MATERIALS

Quality Documentation

- HMC Legacy PCN: MS##, MS##E and MS##G,MS##GE packages - Relocation of pre-existing production equipment to new building
- Package/Assembly Qualification Test Report: Plastic Encapsulated MSOP (QTR: 02016 REV: 01)
- PCN: MS, QS, SOT, SOIC packages - Sn/Pb plating vendor change
- Semiconductor Qualification Test Report: MESFET-B (QTR: 2013-00245)

DESIGN RESOURCES

- HMC175 Material Declaration
- PCN-PDN Information
- Quality And Reliability
- Symbols and Footprints

DISCUSSIONS

View all HMC175 EngineerZone Discussions.

SAMPLE AND BUY

Visit the product page to see pricing options.

TECHNICAL SUPPORT

Submit a technical question or find your regional support number.

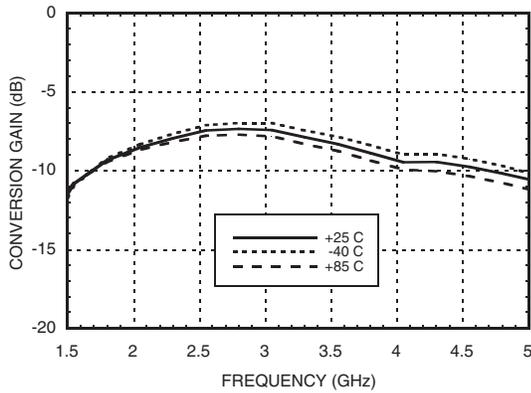
DOCUMENT FEEDBACK

Submit feedback for this data sheet.

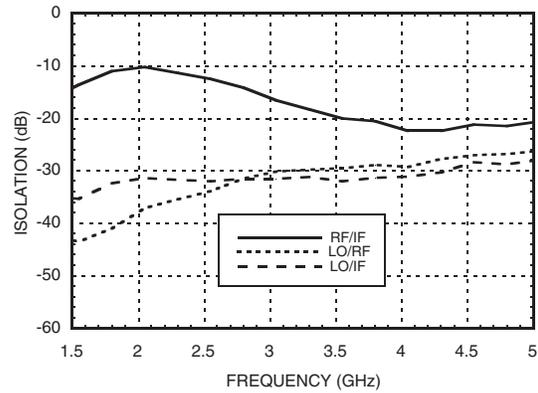


GaAs MMIC SMT DOUBLE-BALANCED MIXER, 1.7 - 4.5 GHz

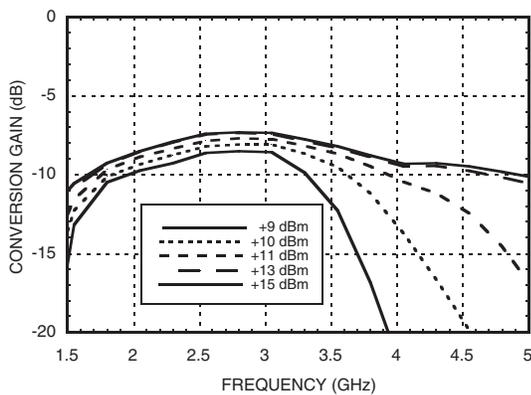
Conversion Gain vs Temperature @ LO = +13 dBm



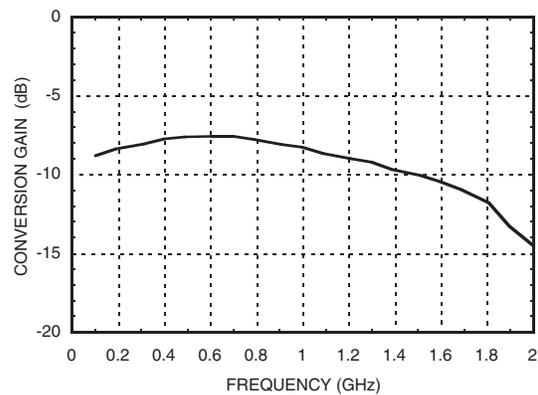
Isolation @ LO = +13 dBm



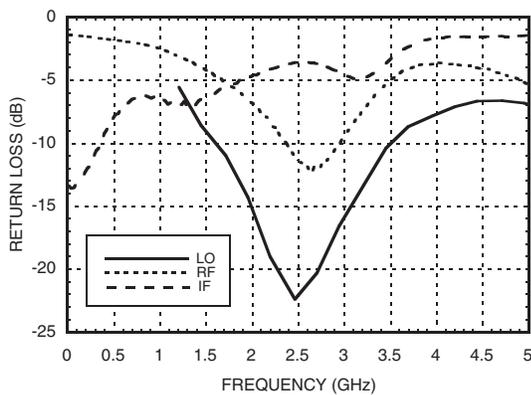
Conversion Gain vs LO Power



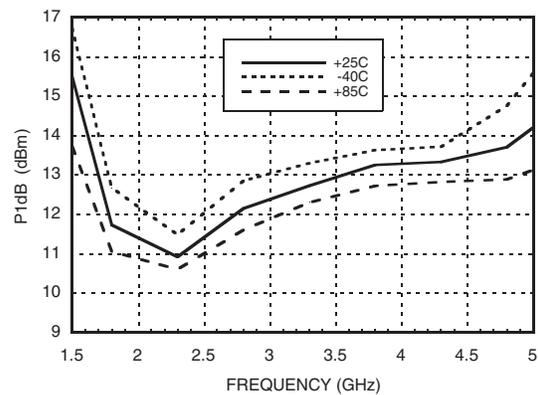
IF Bandwidth @ LO = +13 dBm



Return Loss @ LO = +13 dBm



P1dB vs Temperature @ LO = +13 dBm



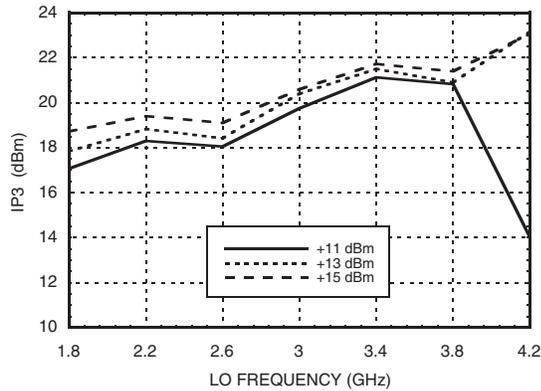
Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

For price, delivery, and to place orders: Analog Devices, Inc., One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106 Phone: 781-329-4700 • Order online at www.analog.com Application Support: Phone: 1-800-ANALOG-D

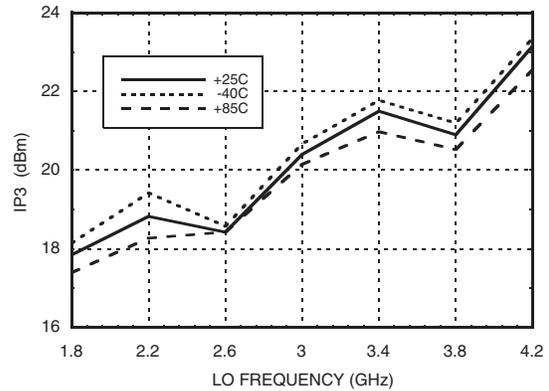


GaAs MMIC SMT DOUBLE-BALANCED MIXER, 1.7 - 4.5 GHz

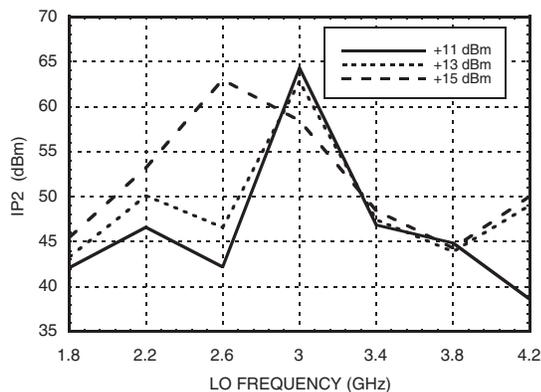
Input IP3 vs. LO Drive



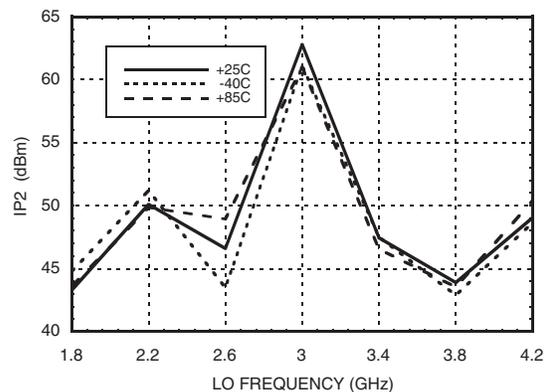
Input IP3 vs. Temperature @ LO = +13 dBm



Input IP2 vs. LO Drive



Input IP2 vs. Temperature @ LO = +13 dBm



MxN Spurious Outputs

RF Frequency = 2.3 GHz @ -10 dBm					
LO Frequency = 2.4 GHz @ 13 dBm					
		nLO			
mRF	0	1	2	3	4
0	xx	1	12	12	37
1	4	0	27	39	38
2	74	53	56	60	67
3	78	>105	73	72	79
4	>105	>105	>105	>105	>105

All values in dBc below IF power level.

Harmonics of LO

LO Freq. (GHz)	nLO Spur at RF Port			
	1	2	3	4
1.8	37	32	63	53
2.2	35	30	37	63
2.6	32	28	33	55
3	30	29	53	52
3.1	29	30	56	51
3.6	29	39	52	53
4.2	27	46	48	61

LO = +13 dBm
Values in dBc below input LO level measured at RF Port.

GaAs MMIC SMT DOUBLE-BALANCED MIXER, 1.7 - 4.5 GHz



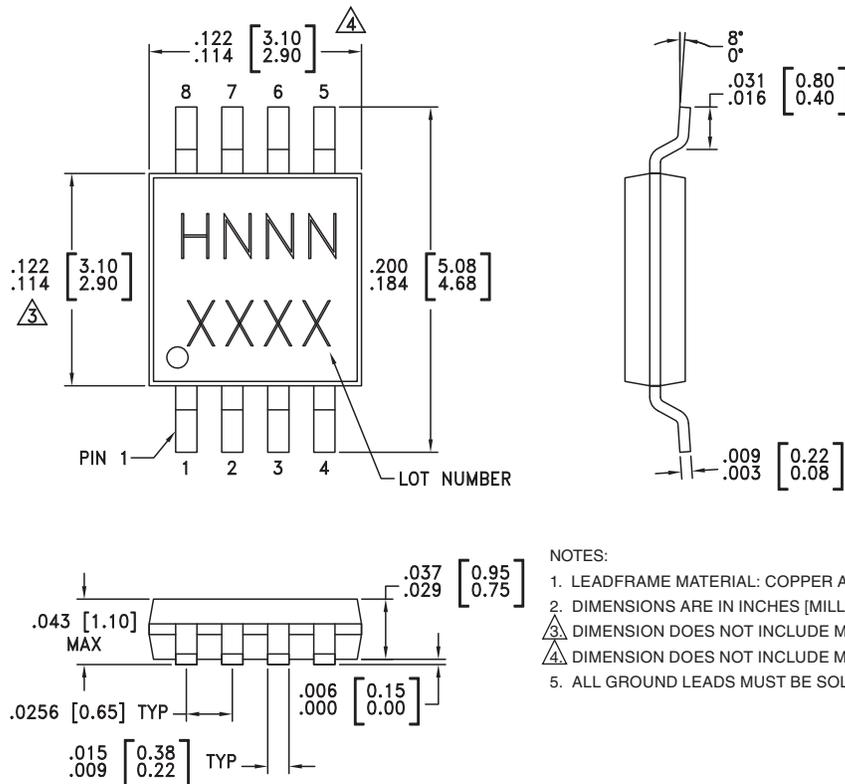
Absolute Maximum Ratings

RF / IF Input	+13 dBm
LO Drive	+27 dBm
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A



**ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS**

Outline Drawing



NOTES:

1. LEADFRAME MATERIAL: COPPER ALLOY
2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- ⚠ DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
- ⚠ DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
5. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[3]
HMC175MS8	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 ^[1]	H175 XXXX
HMC175MS8E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 ^[2]	H175 XXXX

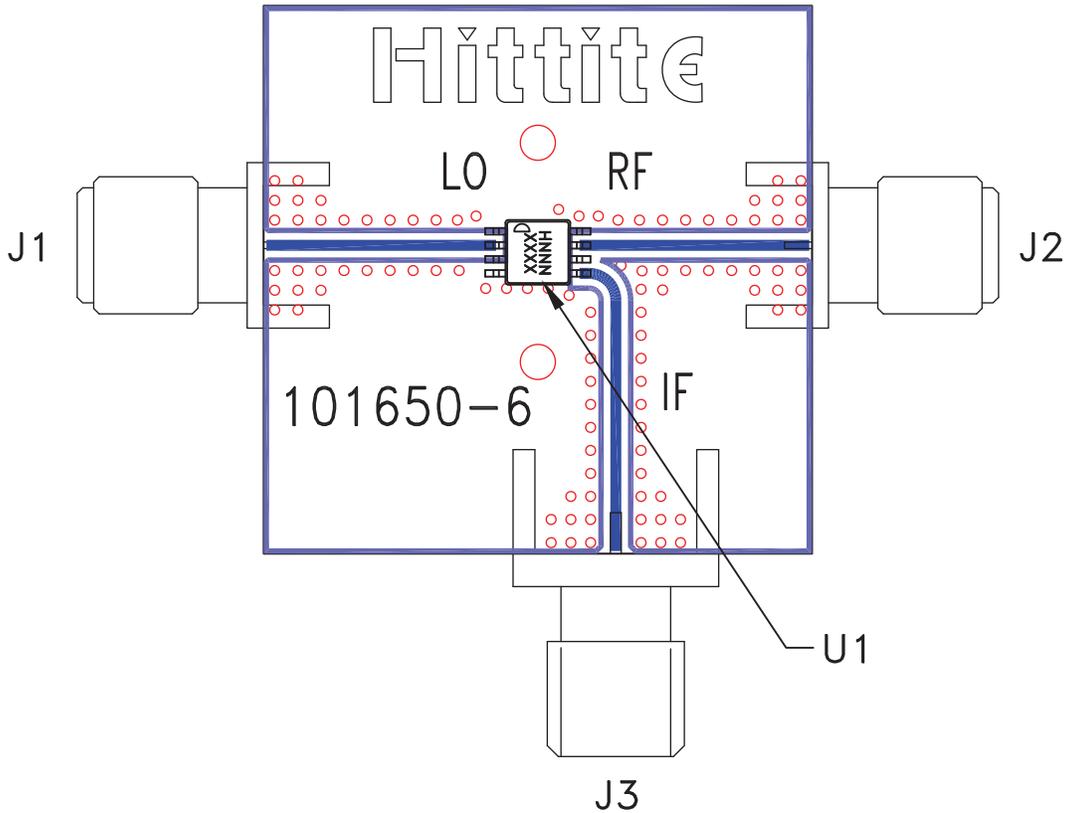
[1] Max peak reflow temperature of 235 °C

[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX



Evaluation Circuit Board



List of Materials for Evaluation PCB 103350 [1]

Item	Description
J1 - J3	PCB Mount SMA RF Connector
U1	HMC175MS8 / HMC175MS8E Mixer
PCB [2]	101650 Evaluation Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.



Notes:

HMC175MS8 / 175MS8E

v02.0705

GaAs MMIC SMT DOUBLE-BALANCED MIXER, 1.7 - 4.5 GHz

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

For price, delivery, and to place orders: Analog Devices, Inc., One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106 Phone: 781-329-4700 • Order online at www.analog.com Application Support: Phone: 1-800-ANALOG-D

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Analog Devices Inc.:](#)

[HMC175MS8E](#) [HMC175MS8](#) [103350-HMC175MS8](#) [HMC175MS8ETR](#) [HMC175MS8TR](#)